



60V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C
-60V	$150 \text{m}\Omega$ @ $V_{GS} = -10V$	-9.4A
	185mΩ @ $V_{GS} = -4.5V$	-8.5A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- DC-DC Converters
- Power Management Functions

Features

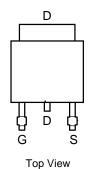
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

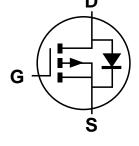
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208@3
- Weight: 0.33 grams (Approximate)



Top View





Equivalent Circuit

Ordering Information (Note 4)

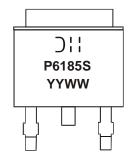
Product	Case	Packaging
DMP6185SK3-13	TO252 (DPAK)	2,500/Tape & Reel

Pin-Out

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



O':| = Manufacturer's Marking P6185S = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 16 = 2016) WW = Week (01 to 53)



Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-60	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Dusin Courset (Nata CVV)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-3.6 -2.8	А
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _C = +25°C T _C = +70°C	I _D	-9.4 -7.5	А
Maximum Body Diode Continuous Current			I _S	-2	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-15	Α
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	-16	Α
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	13	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	1.6	W	
Total Fower Dissipation (Note 5)	$T_A = +70^{\circ}C$	PD	1.0		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	$R_{\theta,JA}$	75	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	Көја	38		
Total Power Dissipation (Note 6)	$T_A = +25$ °C	Pn	2.8	w	
Total Fower Dissipation (Note o)	$T_A = +70^{\circ}C$	PD	1.8	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	44	°C/W	
Themal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	20		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	6.2			
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-60	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(TH)}$	-1.0	_	-3.0	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance			120	150	mΩ	$V_{GS} = -10V, I_{D} = -12A$	
Static Dialif-Source Off-Nesistance	R _{DS(ON)}		150	185	11122	$V_{GS} = -4.5V, I_{D} = -8A$	
Diode Forward Voltage	V_{SD}		-0.75	-1.2	٧	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	708	_	pF	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Output Capacitance	Coss		39	_	рF	$V_{DS} = -30V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss		32	_	рF	1 – 1.000112	
Gate Resistance	R_{g}		17	40	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Q_g	_	6.2	_	nC		
Total Gate Charge (V _{GS} = -10V)	Q_{g}		14	_	nC	$V_{DS} = -30V$, $I_{D} = -12A$	
Gate-Source Charge	Q_{gs}		2.8	_	nC	$V_{DS} = -30V, I_{D} = -12A$	
Gate-Drain Charge	Q_{gd}		3.1	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	5.2	_	ns		
Turn-On Rise Time	t _R	_	23	_	ns	$V_{DS} = -30V, R_{L} = 2.5\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	33	_	ns	$V_{GS} = -10V$, $R_G = 3\Omega$	
Turn-Off Fall Time	t _F	_	39	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	_	22	_	ns	I 12A di/dt _ 100A/us	
Body Diode Reverse Recovery Charge	Q_{RR}	_	17	_	nC	$I_F = -12A$, di/dt = 100A/ μ s	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

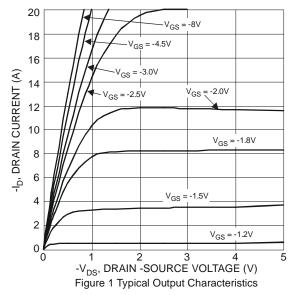
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

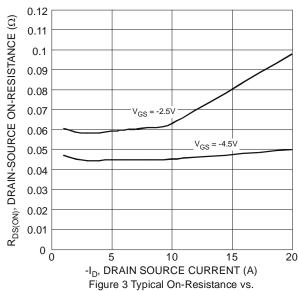
^{7.} I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25$ °C.

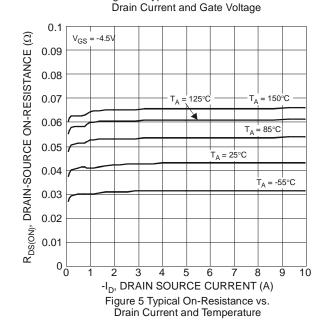
^{8.} Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

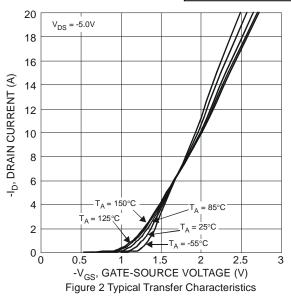




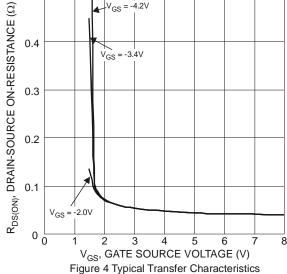








0.5 $V_{GS} = -4.2V$ 0.4 $V_{GS} = -3.4V$



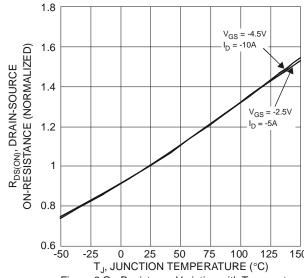
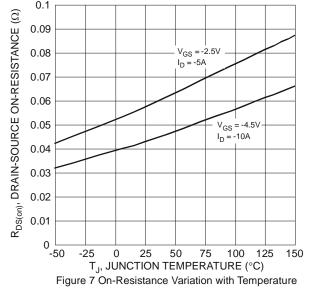
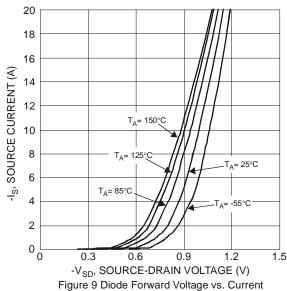
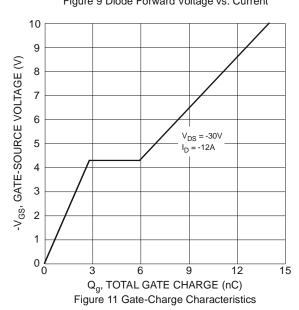


Figure 6 On-Resistance Variation with Temperature









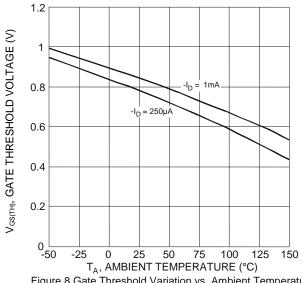
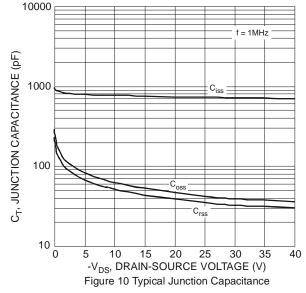
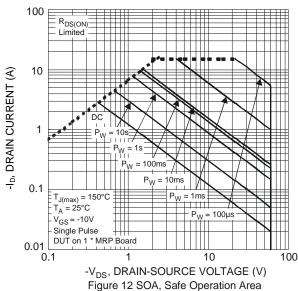
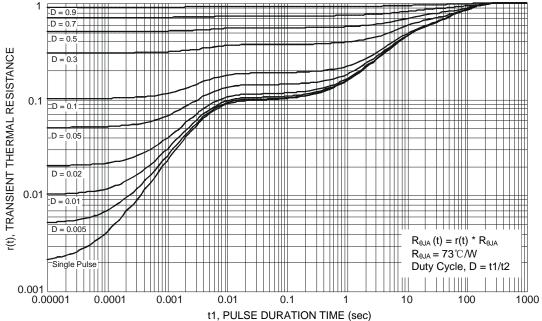


Figure 8 Gate Threshold Variation vs. Ambient Temperature









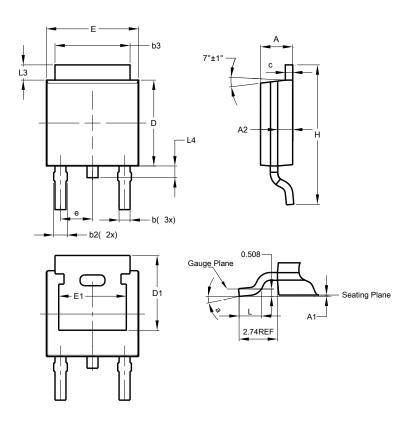
t1, PULSE DURATION TIME (sec)
Figure 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

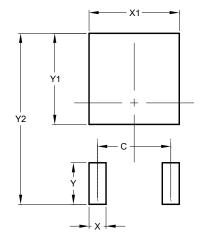


TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
E	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
Y2	10.700		



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